

	Type	Hits	Search Text	DBs
1	IS&R	6	((("6518167") or ("6492266") or ("6303505")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
2	BRS	14864	438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,645649,651,653,655,658,664,672,678,682,694.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
3	BRS	1792	438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,645649,651,653,655,658,664,672,678,682,694.ccls. and (substrate with (copper or (Cu)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
4	BRS	0	((438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,645649,651,653,655,658,664,672,678,682,694.ccls. and (substrate with (copper or (Cu))) ) and ((first adj plasma) with (copper or Cu))) and ((second adj plasma) with (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
5	BRS	10	(438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,645649,651,653,655,658,664,672,678,682,694.ccls. and (substrate with (copper or (Cu))) ) and ((first adj plasma) with (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
6	BRS	26	(438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,645649,651,653,655,658,664,672,678,682,694.ccls. and (substrate with (copper or (Cu))) ) and (first adj plasma) and (second adj plasma)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
7	BRS	3219	copper adj interconnect\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
8	BRS	9	(copper adj interconnect\$4) and ((first adj plasma adj (treatment or anneal\$4)) with (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
9	BRS	0	(copper adj interconnect\$4) and ((first adj plasma adj (treatment or anneal\$4)) with (copper or Cu)) and ((second adj plasma adj (treatment or anneal\$4)) with (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Tim Stamp	Comments	Error Definition	Errors
1	2004/04/07 14:15			0
2	2004/04/07 14:21			0
3	2004/04/08 10:14			0
4	2004/04/08 11:04			0
5	2004/04/07 14:29			0
6	2004/04/07 16:28			0
7	2004/04/08 08:55			0
8	2004/04/07 16:36			0
9	2004/04/07 16:37			0

	Type	Hits	Search Text	DBs
10	BRS	0	(copper adj interconnect\$4) and ((first adj plasma adj (treatment or anneal\$4)) with (copper or Cu)) and ((second adj plasma adj (treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
11	BRS	4	((first adj plasma adj (treatment or anneal\$4)) with (copper or Cu)) and ((second adj plasma adj (treatment or anneal\$4)) with (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
12	BRS	12	((first adj plasma adj (treatment or anneal\$4)) same (copper or Cu)) and ((second adj plasma adj (treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
13	BRS	14	((first near2 plasma near2 (treatment or anneal\$4)) same (copper or Cu)) and ((second near2 plasma near2 (treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
14	BRS	748421	interconnect\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
15	BRS	0	interconnect\$4 and ((first adj plasma adj (treatment or anneal\$4)) with (copper or Cu)) and ((second adj plasma adj (treatment or anneal\$4)) with (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
16	BRS	6	interconnect\$4 and ((first adj plasma adj (treatment or anneal\$4)) same (copper or Cu)) and ((second adj plasma adj (treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
17	BRS	6	interconnect\$4 and ((first adj plasma adj (etch\$4 or clean\$4 or treatment or anneal\$4)) same (copper or Cu)) and ((second adj plasma adj (etch\$4 or clean\$4 or treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
18	BRS	6	interconnect\$4 and ((first adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)) same (copper or Cu)) and ((second adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Time Stamp	Comments	Error Definition	Errors
10	2004/04/07 16:37			0
11	2004/04/08 08:56			0
12	2004/04/07 16:45			0
13	2004/04/07 16:46			0
14	2004/04/08 08:56			0
15	2004/04/08 08:57			0
16	2004/04/08 09:48			0
17	2004/04/08 13:00			0
18	2004/04/08 09:51			0

	Type	Hits	Search Text	DBs
19	BRS	16760	438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,637,645,649,651,653,652,654,655,658,664,672,676,677,678,682,694,785,902.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
20	BRS	8	438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,637,645,649,651,653,652,654,655,658,664,672,676,677,678,682,694,785,902.ccls. and ((first adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)) same (copper or Cu)) and ((second adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)) same (copper or Cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
21	BRS	8	438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,637,645,649,651,653,652,654,655,658,664,672,676,677,678,682,694,785,902.ccls. and ((first adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)) same (copper or Cu or (copper adj oxide))) and ((second adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)) same (copper or Cu or (copper adj oxide)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
22	BRS	10	438/622,643,672,680,686,639,687,693,688,644,626,627,629,630,631,633,637,645,649,651,653,652,654,655,658,664,672,676,677,678,682,694,785,902.ccls. and ((copper or Cu or (copper adj oxide)) same (second adj plasma adj (etch\$4 or preclean\$4 or treatment or anneal\$4)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Time Stamp	Comments	Error Definition	Errors
19	2004/04/08 11:04			0
20	2004/04/08 11:06			0
21	2004/04/08 11:20			0
22	2004/04/08 11:25			0